# Dual P-Channel Enhancement Mode Power MOSFET

## Description

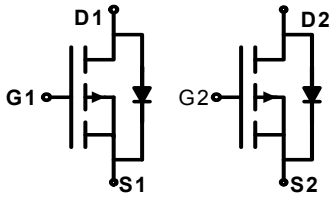
The HM4885 uses advanced trench technology to provide excellent $R_{DS(ON)}$, This device is suitable for use as a load switch or in PWM applications.

## General Features

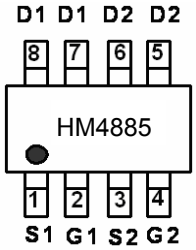
- $V_{DS}$ = -40V,$I_D$ = -7.5A
  $R_{DS(ON)}$ <42mΩ @ $V_{GS}$=-10V
  $R_{DS(ON)}$ <70mΩ @ $V_{GS}$=-4.5V
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

## Application

- PWM applications
- Load switch
- Uninterruptible power supply




**Schematic diagram**




**Marking and pin Assignment**

**SOP-8 top view**

## Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|---|---|---|---|---|---|
| HM4885 | HM4885 | SOP-8 | Ø330mm | 12mm | 2500 units |

## Absolute Maximum Ratings ($T_A$=25℃unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|---|---|---|---|
| Drain-Source Voltage | $V_{DS}$ | -40 | V |
| Gate-Source Voltage | $V_{GS}$ | ±20 | V |
| Drain Current-Continuous | $I_D$ | -7.5 | A |
| Drain Current-Pulsed (Note 1) | $I_{DM}$ | -40 | A |
| Maximum Power Dissipation | $P_D$ | 3.1 | W |
| Operating Junction and Storage Temperature Range | $T_J$,$T_{STG}$ | -55 To 150 | ℃ |

## Thermal Characteristic

| | | | |
|---|---|---|---|
| Thermal Resistance,Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 40 | ℃/W |

## Electrical Characteristics ($T_A$=25℃unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| **Off Characteristics** | | | | | | |
| Drain-Source Breakdown Voltage | $BV_{DSS}$ | $V_{GS}$=0V $I_D$=-250μA | -40 | -44 | - | V |

| | | | | | | |
|---|---|---|---|---|---|---|
| Zero Gate Voltage Drain Current | $I_{DSS}$ | $V_{DS}$=-30V,$V_{GS}$=0V | - | - | -1 | μA |
| Gate-Body Leakage Current | $I_{GSS}$ | $V_{GS}$=±20V,$V_{DS}$=0V | - | - | ±100 | nA |
| **On Characteristics** (Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}$=$V_{GS}$,$I_D$=-250μA | -1.0 | -2.0 | -3.0 | V |
| Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS}$=-10V, $I_D$=-7.5A | - | 30 | 42 | mΩ |
| | | $V_{GS}$=-4.5V, $I_D$=-6A | - | 49 | 70 | mΩ |
| Forward Transconductance | $g_{FS}$ | $V_{DS}$=-5V,$I_D$=-7.5A | 30 | - | - | S |
| **Dynamic Characteristics** (Note4) | | | | | | |
| Input Capacitance | $C_{lss}$ | $V_{DS}$=-15V,$V_{GS}$=0V, F=1.0MHz | - | 2900 | - | PF |
| Output Capacitance | $C_{oss}$ | | - | 410 | - | PF |
| Reverse Transfer Capacitance | $C_{rss}$ | | - | 280 | - | PF |
| **Switching Characteristics** (Note 4) | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}$=-15V, ID=-7.5A, $V_{GS}$=-10V,$R_{GEN}$=3Ω | - | 15 | - | nS |
| Turn-on Rise Time | $t_r$ | | - | 11 | - | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 44 | - | nS |
| Turn-Off Fall Time | $t_f$ | | - | 21 | - | nS |
| Total Gate Charge | $Q_g$ | $V_{DS}$=-15V,$I_D$=-7.5A,$V_{GS}$=-10V | - | 48 | - | nC |
| Gate-Source Charge | $Q_{gs}$ | | - | 12 | - | nC |
| Gate-Drain Charge | $Q_{gd}$ | | - | 14 | - | nC |
| **Drain-Source Diode Characteristics** | | | | | | |
| Diode Forward Voltage (Note 3) | $V_{SD}$ | $V_{GS}$=0V,$I_S$=-2A | - | - | -1.2 | V |

**Notes**

**1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
**2.** Surface Mounted on FR4 Board, t ≤ 10 sec.
**3.** Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
**4.** Guaranteed by design, not subject to production

## Typical Electrical and Thermal Characteristics

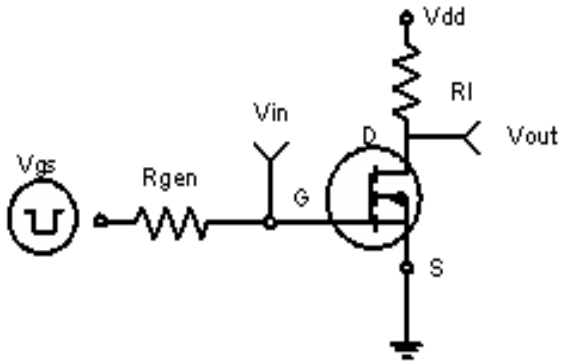



**Figure 1 Switching Test Circuit**

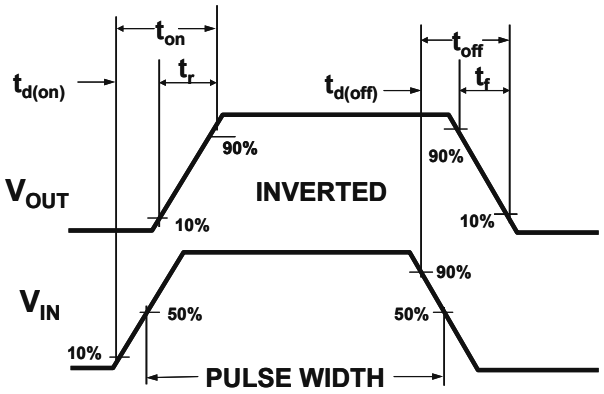



**Figure 2 Switching Waveforms**

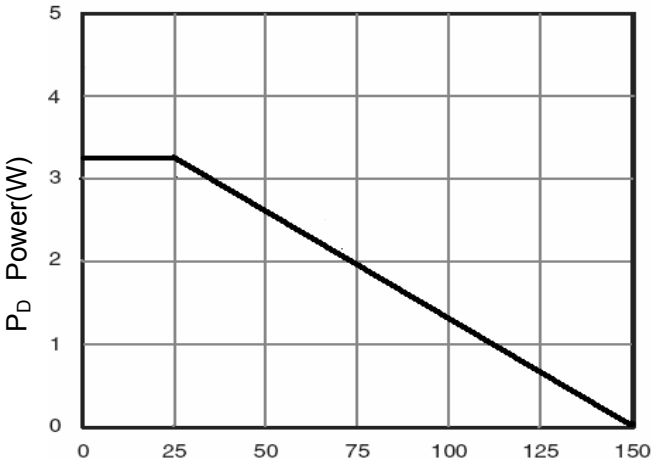



**Figure 3 Power Dissipation**

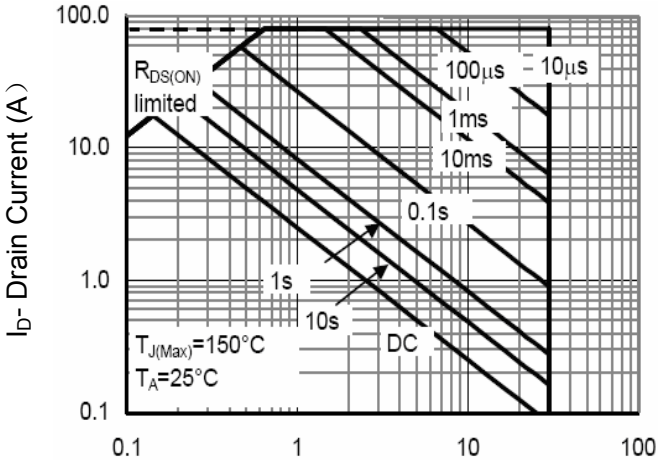



**Figure 4 Safe Operation Area**

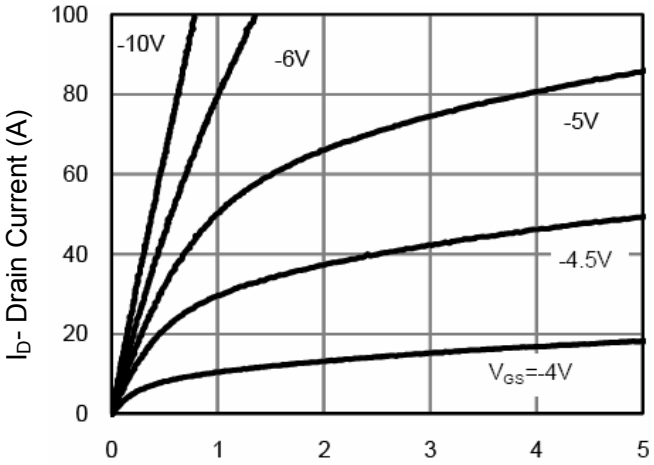



**Figure 5 Output Characteristics**

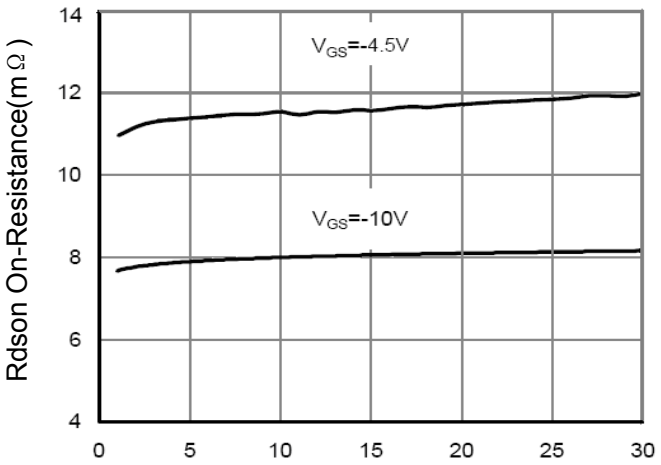



**Figure 6 Drain-Source On-Resistance**

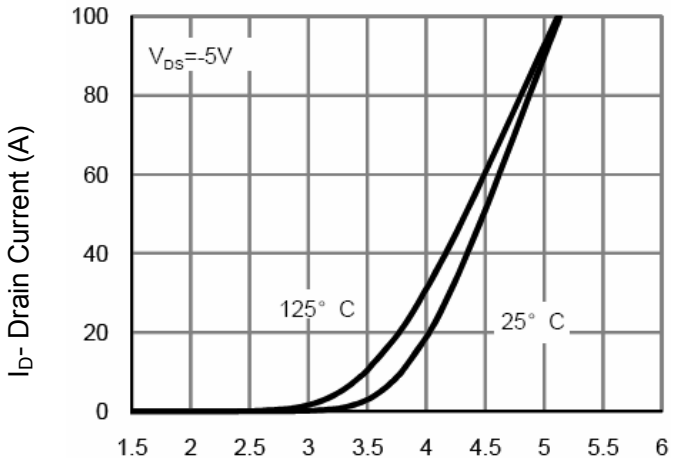



**Figure 7 Transfer Characteristics**

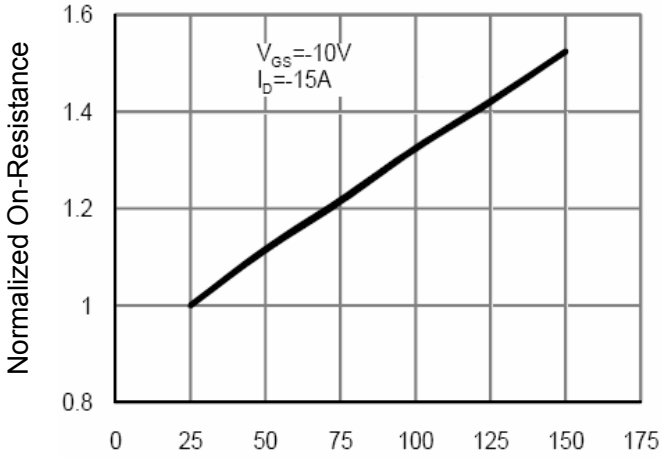



**Figure 8 Drain-Source On-Resistance**

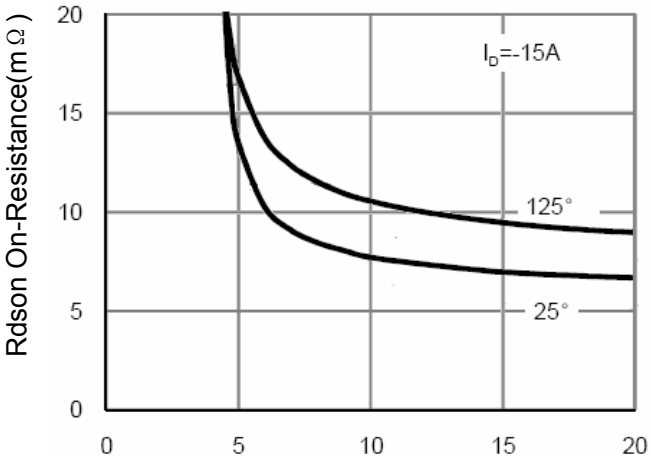



**Figure 9 Rdson vs Vgs**

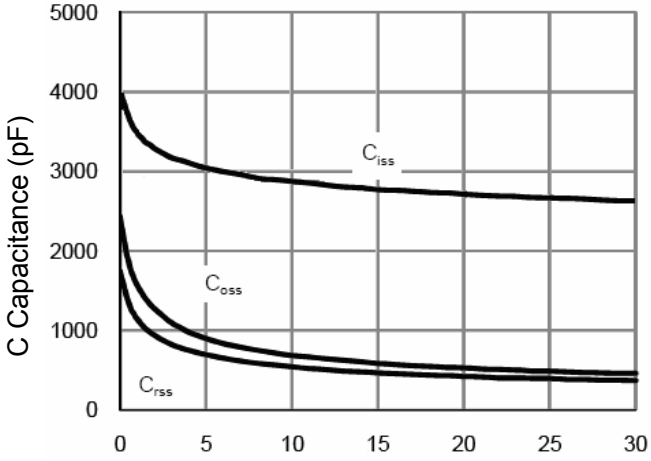



**Figure 10 Capacitance vs Vds**

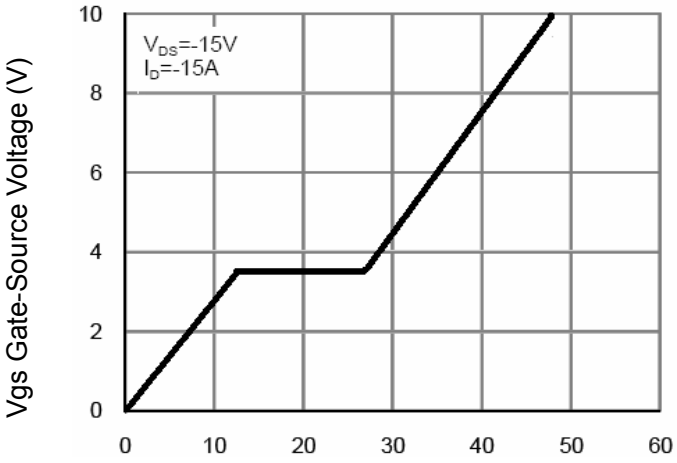



**Figure 11 Gate Charge**

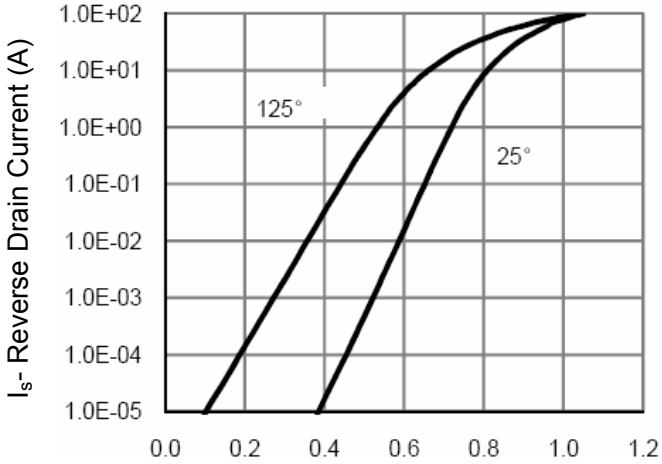



**Figure 12 Source- Drain Diode Forward**

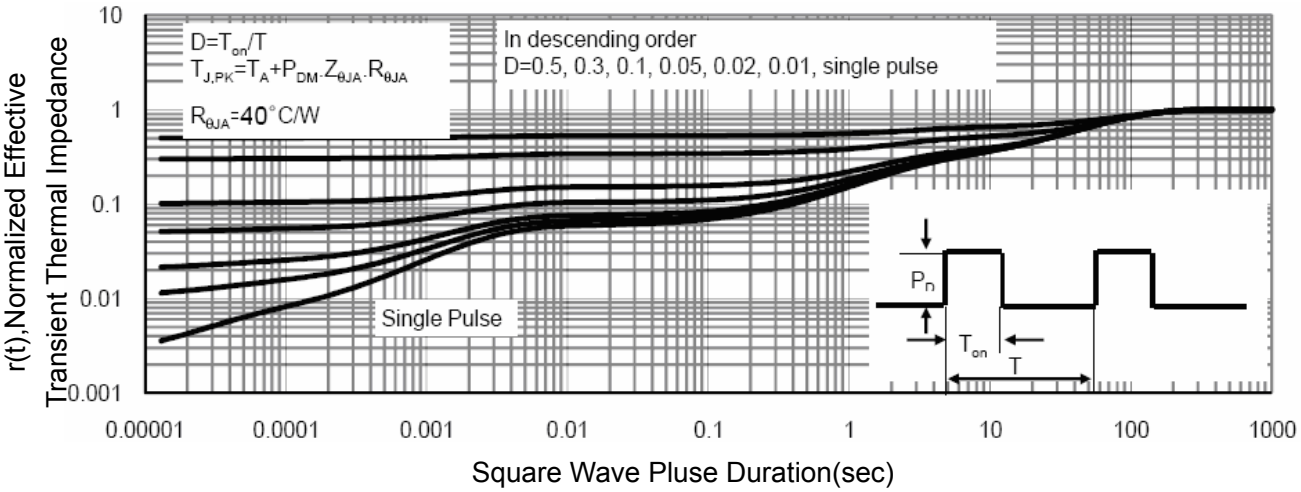
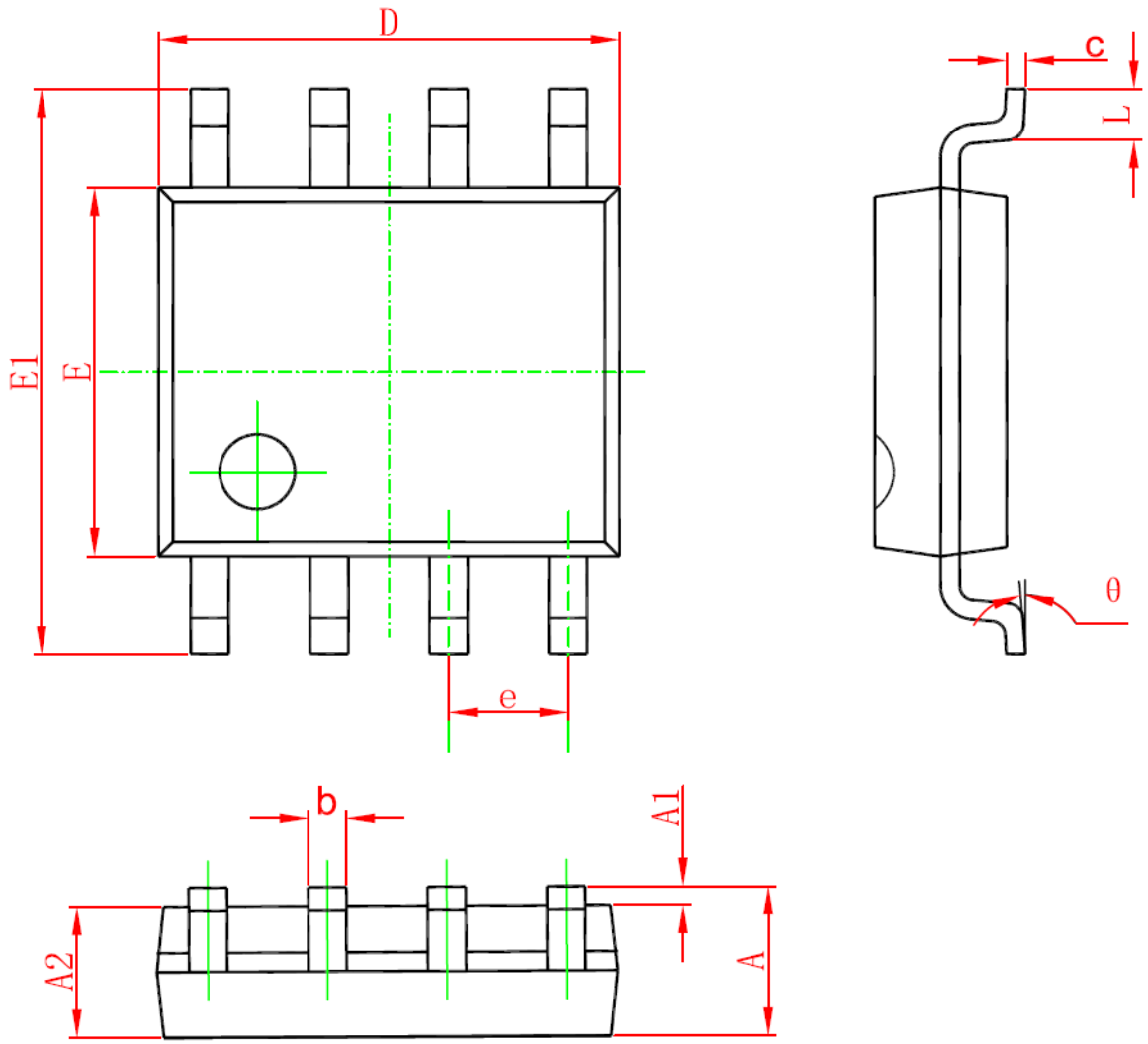



**Figure 13 Normalized Maximum Transient Thermal Impedance**

## SOP-8 Package Information




| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|---|---|---|---|---|
| | Min | Max | Min | Max |
| A | 1.350 | 1.750 | 0.053 | 0.069 |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 |
| b | 0.330 | 0.510 | 0.013 | 0.020 |
| c | 0.170 | 0.250 | 0.006 | 0.010 |
| D | 4.700 | 5.100 | 0.185 | 0.200 |
| E | 3.800 | 4.000 | 0.150 | 0.157 |
| E1 | 5.800 | 6.200 | 0.228 | 0.244 |
| e | 1.270(BSC) | | 0.050(BSC) | |
| L | 0.400 | 1.270 | 0.016 | 0.050 |
| θ | 0° | 8° | 0° | 8° |

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